Page 1 of 2 Pages	[] Original	[] Substitut	e [] Suppl	emental	At	ty. Docket:
Combin	ed Declaration	for Patent	Applicatio	n and Power	of Attorne	e v
á below-named inven			÷. =		٠,	
residence, post office and sole inventor (if onl the subject matter which	e address and citizens ly one name is listed l	ship are as stated below) or an orig	ginal, first and jo	oint inventor (if pl	I believe I am th ural names are l	e original, first isted below) of
METHOD OF MA					IC DOUBLE	LAYER
the specification of which	h (check one) CAP	ACITOR				
[X] was	attached hereto; s filed in the United S S. Appln. Nd.0/724	tates under 35 U	J.S.C. §111 on <u>Oʻ</u>	1/12/2003	_, as	
[] 'was	s/will be filed in the UCT) application,		S.C. §371 by ent	try into the U.S. na		n international equested on
1.				ed U.S. Appln. No		; §371/§102(e)
date	e	_* (* if known)		-		
and was amended on	nclude dates of amendme		10 124 : CDC/701	(if applicable).		•
(D	iciuae dates of amename	ents under PCT Art.	19 and 34 if PCT)			
I have reviewed and und amendment referred to a known by me to be mater	bove; and I acknowled	dge the duty to d	isclose to the Pa	ation, including the tent and Trademar	he claims, as an k Office (PTO)	nended by any all information
I hereby claim foreign pr	iority benefits under	35 U.S.C. §§ 11	9 (a)-(d) and 365	(b) of any prior f	oreign applicatio	on(s) for patent
or inventor's certificate, a the "Yes" box checked, a certificate or PCT interna	or §365(a) of any pric and have also identifie	or PCT applicatied below, by chec	on(s) designating king the "No" bo	g a country other the country other the country other the country any foreign app	han the U.S., list dication for pate	ted below with nt or inventor's
2002-34793	37Japa	an	29/11/20	0.2	י י	
(Number)	(Cour	ntry)	(Day Month)	Year Filed)	[X] [] YES NO	
2002-34793 (Number)	38 Japa (Cour		29/11/20 (Day Month)		[X] [] YES NO	
I hereby claim the benefit	(Application			onal applications li	sted below.	
	(Application	on No.)		nth Year Filed)		
hereby claim the beneficT international application is not disclosts. S.C. §112, I acknowled. F.R. §1.56 which becaling date of this application.	ation(s) designating the sed in such U.S. or Pe dge the duty to disclo ume available between	ne U.S., listed be CT international ose to the PTO a	low and, insofar application in t ll information w	as the subject mat he manner provide hich is material to	ter of each of the ed by the first pa patentability as	claims of this aragraph of 35 defined in 37
(Application N	lo.)	(Day Month Year	Filed)	(Status: patented	, pending, abandon	ed)
(Application N	lo.)	(Day Month Year	Filed)	(Status: patented	, pending, abandon	ed)
As a named inventor, I housiness in the Patent and				to prosecute this	application and	to transact all
	All of the practi	tioners associate	ed with Custome	er Number 00144	4	
Direct all correspondence						
		624 Ninth Str			,	
		(202) 628-519		J		
The undersigned hereby at	as to a	ny action to be	taken in the U.	S. Patent and Tra	demark Office	regarding this
The undersigned hereby a application without direct the persons from whom i undersigned.	as to a communication between	Washington, 1 (202) 628-519 torneys or Agents ny action to be een the U.S. Atto	D.C. 20001-530 7 s appointed herei taken in the U. prneys or Agents	n to accept and fol S. Patent and Tra and the undersign	demark Office and offi	regard of a cl

Page 2 of 2 Pages Title:			Atty. Docket:
U.S. Application filed	Serial No.		
PCT Application filed			
I hereby further declare that all statements made he information and belief are believed to be true; and to statements and the like so made are punishable by fin false statements may jeopardize the validity of the appli	that these statements were made e or imprisonment, or both, unde	e with the know or 18 U.S.C. §10	ledge that willful false
FULL NAME OF FIRST INVENTOR	INVENTOR'S SIGNATURE		DATE
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POST OFFICE ADDRESS		<u> </u>	
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RESIDENCE		CITIZENSHIP	
POST OFFICE ADDRESS			